## NL17SG08

## Single 2-Input AND Gate

The NL17SG08 MiniGate ${ }^{T M}$ is an advanced high-speed CMOS 2-input AND gate in ultra-small footprint.

The NL17SG08 input structures provides protection when voltages up to 4.6 V are applied.

## Features

- Wide Operating $\mathrm{V}_{\mathrm{CC}}$ Range: 0.9 V to 3.6 V
- High Speed: $\mathrm{t}_{\mathrm{PD}}=2.5 \mathrm{~ns}(\mathrm{Typ})$ at $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$
- Low Power Dissipation: $\mathrm{I}_{\mathrm{CC}}=0.5 \mu \mathrm{~A}(\mathrm{Max})$ at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
- 4.6 V Overvoltage Tolerant (OVT) Input Pins
- Ultra-Small Packages
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are $\mathrm{Pb}-$ Free and Halide-Free Devices


Figure 1. SOT-953 (Top Thru View)


Figure 1. SC-88A
(Top View)


Figure 1. UDFN6
(Top View)


Figure 2. Logic Symbol


## ON Semiconductor ${ }^{\circledR}$

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(Note: Microdot may be in either location)
*Date Code orientation and/or position may vary depending upon manufacturing location.

## PIN ASSIGNMENT

| PIN | SOT-953 | SC-88A | UDFN6 |
| :---: | :---: | :---: | :---: |
| 1 | IN A | IN B | IN B |
| 2 | GND | IN A | IN A |
| 3 | IN B | GND | GND |
| 4 | OUT Y | OUT Y | OUT Y |
| 5 | $\mathrm{~V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}$ | VC |
| 6 | - | - | $\mathrm{V}_{\mathrm{CC}}$ |

FUNCTION TABLE

| Inputs |  | Output |
| :---: | :---: | :---: |
| A | B | Y |
| L | L | L |
| L | H | L |
| H | L | L |
| H | H | H |

ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

MAXIMUM RATINGS


Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm -by-1 inch, 2-ounce copper trace with no air flow.
2. Tested to EIA/JESD22-A114-A.
3. Tested to EIA/JESD22-A115-A.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Characteristics |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Voltage |  | 0.9 | 3.6 | V |
| $\mathrm{V}_{\text {IN }}$ | Digital Input Voltage |  | 0.0 | 3.6 | V |
| $\mathrm{V}_{\text {OUT }}$ | Output Voltage | Output at High or Low State Power-Down Mode ( $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ ) | $\begin{aligned} & \hline 0.0 \\ & 0.0 \end{aligned}$ | $\begin{gathered} \hline \mathrm{V}_{\mathrm{CC}} \\ 3.6 \end{gathered}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range |  | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta t / \Delta V$ | Input Transition Rise or Fail Rate | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | 0 | 10 | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Conditions |  | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $\begin{gathered} \mathrm{T}_{\mathrm{A}}= \\ -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{gathered}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-Level Input Voltage |  |  |  | 0.9 | $\mathrm{V}_{\mathrm{CC}}$ |  | $\mathrm{V}_{\mathrm{CC}}$ |  | V |
|  |  |  |  | 1.1 to 1.3 | $0.7 \times V_{\text {CC }}$ |  | $0.7 \times V_{\text {CC }}$ |  |  |  |
|  |  |  |  | 1.4 to 1.6 | $0.65 \times \mathrm{V}_{\text {cC }}$ |  | $0.65 \times V_{\text {cC }}$ |  |  |  |
|  |  |  |  | 1.65 to 1.95 | $0.65 \times \mathrm{V}_{\text {cC }}$ |  | $0.65 \times \mathrm{V}_{\text {cC }}$ |  |  |  |
|  |  |  |  | 2.3 to 2.7 | 1.7 |  | 1.7 |  |  |  |
|  |  |  |  | 3.0 to 3.6 | 2.0 |  | 2.0 |  |  |  |
| $\mathrm{V}_{\mathrm{IL}}$ | Low-Level Input Voltage |  |  | 0.9 |  | GND |  | GND | V |  |
|  |  |  |  | 1.1 to 1.3 |  | $0.3 \times \mathrm{V}_{\text {CC }}$ |  | $0.3 \times \mathrm{V}_{\text {CC }}$ |  |  |
|  |  |  |  | 1.4 to 1.6 |  | $0.35 \times \mathrm{V}_{\text {CC }}$ |  | $0.35 \times \mathrm{V}_{\text {CC }}$ |  |  |
|  |  |  |  | 1.65 to 1.95 |  | $0.35 \times \mathrm{V} \mathrm{VCC}$ |  | $0.35 \times \mathrm{V}_{\text {CC }}$ |  |  |
|  |  |  |  | 2.3 to 2.7 |  | 0.7 |  | 0.7 |  |  |
|  |  |  |  | 3.0 to 3.6 |  | 0.8 |  | 0.8 |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-Level Output Voltage | $\begin{aligned} & \mathrm{V}_{\text {IN }}= \\ & \mathrm{V}_{\mathrm{IH} \text { or }} \\ & \mathrm{V}_{\mathrm{IL}} \end{aligned}$ | $\mathrm{I}_{\mathrm{OH}}=-20 \mu \mathrm{~A}$ | 0.9 | 0.75 |  | 0.75 |  | V |  |
|  |  |  | $\mathrm{I}_{\mathrm{OH}}=-0.3 \mathrm{~mA}$ | 1.1 to 1.3 | $0.75 \times \mathrm{V}_{\mathrm{CC}}$ |  | $0.75 \times \mathrm{V}_{\mathrm{CC}}$ |  |  |  |
|  |  |  | $\mathrm{I}_{\mathrm{OH}}=-1.7 \mathrm{~mA}$ | 1.4 to 1.6 | $0.75 \times \mathrm{V}_{\mathrm{CC}}$ |  | $0.75 \times \mathrm{V}_{\mathrm{CC}}$ |  |  |  |
|  |  |  | $\mathrm{l}_{\mathrm{OH}}=-3.0 \mathrm{~mA}$ | 1.65 to 1.95 | Vcc-0.45 |  | Vcc-0.45 |  |  |  |
|  |  |  | $\mathrm{IOH}^{\text {a }}=-4.0 \mathrm{~mA}$ | 2.3 to 2.7 | 2.0 |  | 2.0 |  |  |  |
|  |  |  | $\mathrm{IOH}^{\text {a }}=-8.0 \mathrm{~mA}$ | 3.0 to 3.6 | 2.48 |  | 2.48 |  |  |  |
| $\mathrm{V}_{\text {OL }}$ | Low-Level Output Voltage | $\begin{gathered} \mathrm{V}_{\mathrm{IN}}= \\ \mathrm{V}_{\mathrm{IH}} \text { or } \\ \mathrm{V}_{\mathrm{IL}} \end{gathered}$ | l OL $=20 \mu \mathrm{~A}$ | 0.9 |  | 0.1 |  | 0.1 | V |  |
|  |  |  | $\mathrm{I}_{\mathrm{OL}}=1.1 \mathrm{~mA}$ | 1.1 to 1.3 |  | $0.25 \times \mathrm{V}_{\text {CC }}$ |  | $0.25 \times V_{\text {cC }}$ |  |  |
|  |  |  | $\mathrm{I}_{\mathrm{OL}}=1.7 \mathrm{~mA}$ | 1.4 to 1.6 |  | $0.25 \times \mathrm{V}_{\text {cc }}$ |  | $0.25 \times \mathrm{V}_{\text {CC }}$ |  |  |
|  |  |  | $\mathrm{I}_{\text {OL }}=3.0 \mathrm{~mA}$ | 1.65 to 1.95 |  | 0.45 |  | 0.45 |  |  |
|  |  |  | $\mathrm{I}_{\text {OL }}=4.0 \mathrm{~mA}$ | 2.3 to 2.7 |  | 0.4 |  | 0.4 |  |  |
|  |  |  | $\mathrm{I}_{\text {OL }}=8.0 \mathrm{~mA}$ | 3.0 to 3.6 |  | 0.4 |  | 0.4 |  |  |
| 1 IN | Input Leakage Current | $0 \leq \mathrm{V}_{\text {IN }} \leq 3.6 \mathrm{~V}$ |  | 0 to 3.6 |  | $\pm 0.1$ |  | $\pm 1.0$ | $\mu \mathrm{A}$ |  |
| $I_{\text {cc }}$ | Quiescent Supply Current | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {CC }}$ or GND |  | 3.6 |  | 0.5 |  | 10.0 | $\mu \mathrm{A}$ |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (Input $t_{r}=t_{f}=3.0 \mathrm{~ns}$ )

| Symbol | Parameter | Test Condition | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{A}}= \\ -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{gathered}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\begin{aligned} & \text { tpLH, } \\ & \text { tpHL }^{\text {ten }} \end{aligned}$ | Propagation Delay, A or B to Y | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega \end{aligned}$ | 0.9 | - | 10.0 | 12.4 | - | 14.8 | ns |
|  |  |  | 1.1 to 1.3 | - | 8.0 | 10.7 | - | 13.6 |  |
|  |  |  | 1.4 to 1.6 | - | 5.9 | 9.6 | - | 11.3 |  |
|  |  |  | 1.65 to 1.95 | - | 4.5 | 7.0 | - | 7.5 |  |
|  |  |  | 2.3 to 2.7 | - | 2.9 | 4.4 | - | 4.9 |  |
|  |  |  | 3.0 to 3.6 | - | 2.2 | 3.5 | - | 4.1 |  |
|  |  | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega \end{aligned}$ | 0.9 | - | 11.7 | 13.5 | - | 15.0 | ns |
|  |  |  | 1.1 to 1.3 | - | 8.8 | 10.2 | - | 13.7 |  |
|  |  |  | 1.4 to 1.6 | - | 6.5 | 9.5 | - | 12.6 |  |
|  |  |  | 1.65 to 1.95 | - | 5.0 | 7.7 | - | 8.0 |  |
|  |  |  | 2.3 to 2.7 | - | 3.2 | 4.9 | - | 5.6 |  |
|  |  |  | 3.0 to 3.6 | - | 2.5 | 3.8 | - | 4.4 |  |
|  |  | $\begin{gathered} \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}, \\ \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega \end{gathered}$ | 0.9 | - | 13.0 | 16.0 | - | 19.0 | ns |
|  |  |  | 1.1 to 1.3 | - | 10.0 | 12.4 | - | 17.2 |  |
|  |  |  | 1.4 to 1.6 | - | 8.9 | 11.8 | - | 14.9 |  |
|  |  |  | 1.65 to 1.95 | - | 6.9 | 10.3 | - | 10.8 |  |
|  |  |  | 2.3 to 2.7 | - | 4.4 | 6.4 | - | 6.8 |  |
|  |  |  | 3.0 to 3.6 | - | 3.5 | 4.9 | - | 5.4 |  |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  | 0 to 3.6 |  | 3 | - | - | - | pF |
| $\mathrm{C}_{\text {PD }}$ | Power Dissipation Capacitance (Note 4) | $\mathrm{f}=10 \mathrm{MHz}$ | 0.9 to 3.6 | - | 4 | - | - | - | pF |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. $C_{P D}$ is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{C C(O P R)}=C_{P D} \bullet V_{C C} \bullet f_{i n}+I_{C C} . C_{P D}$ is used to determine the no-load dynamic power consumption; $\mathrm{P}_{\mathrm{D}}=\mathrm{C}_{\mathrm{PD}} \bullet \mathrm{V}_{\mathrm{CC}}{ }^{2} \bullet \mathrm{f}_{\mathrm{in}}+\mathrm{I}_{\mathrm{CC}} \bullet \mathrm{V}_{\mathrm{CC}}$.


Figure 2. Switching Waveforms

*Includes all probe and jig capacitance. A 1-MHz square input wave is recommended for propagation delay tests.

Figure 3. Test Circuit

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| NL17SG08P5T5G | SOT-953 <br> (Pb-Free) | $8000 /$ Tape \& Reel |
| NL17SG08DFT2G | SC-88A <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| NLV17SG08DFT2G* | SC-88A <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| NL17SG08AMUTCG | UDFN6 1.45x1 mm <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| NL17SG08CMUTCG | UDFN6 1x1 mm <br> (Pb-Free) | $3000 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 0.071 | 0.087 | 1.80 | 2.20 |
| B | 0.045 | 0.053 | 1.15 | 1.35 |
| C | 0.031 | 0.043 | 0.80 | 1.10 |
| D | 0.004 | 0.012 | 0.10 |  |
| G | 0.026 BSC |  | 0.65 |  |


(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-F r e e$ indicator, " G " or microdot " $\mathrm{=}$ ", may or may not be present. Some products may not follow the Generic Marking.

```
```

STYLE 1:

```
```

STYLE 1:
STYLE 1:
STYLE 1:
2. EMITTER
2. EMITTER
3. BASE
3. BASE
4. COLLECTOR
4. COLLECTOR
5. COLLECTOR

```
```

        5. COLLECTOR
    ```
```

```
STYLE 2:
    PIN 1. ANODE
    2. EMITTER
    STYLE 3
```

STYLE 6:
PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE

STYLE 7:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 3
PIN 1. ANODE
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE

## STYLE 8

PIN 1. CATHODE
2. COLLECTOR
3. $\mathrm{N} / \mathrm{C}$
4. BASE
5. EMITTER

SOLDER FOOTPRINT


STYLE 4:
PIN 1. SOURCE 1
2. DRAIN $1 / 2$
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 9:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

## STYLE 5:

PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | SC-88A (SC-70-5/SOT-353) | PAGE 1 OF 1 |

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UDFN6, 1.45x1.0, 0.5P CASE 517AQ

ISSUE O
DATE 15 MAY 2008


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS
2. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.


DETAIL B OPTIONAL CONSTRUCTIONS

## MOUNTING FOOTPRINT



DIMENSIONS: MILLIMETERS
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## GENERIC

MARKING DIAGRAM*


X = Specific Device Code
M = Date Code
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, "G" or microdot " $\quad$ ", may or may not be present.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | UDFN6, 1.45x1.0, 0.5P | PAGE 1 OF 1 |

[^0]UDFN6, 1x1, 0.35P
CASE 517BX
ISSUE O
DATE 18 MAY 2011

*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, " G " or microdot " $\mathrm{\nabla}$ ", may or may not be present. Some products may not follow the Generic Marking.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | UDFN6, 1x1, 0.35P |  | PAGE 1 OF 1 |

[^1]SCALE 4:1

*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME

Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

|  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: |
| DIM | MIN | NOM | MAX |
| A | 0.34 | 0.37 | 0.40 |
| b | 0.10 | 0.15 | 0.20 |
| C | 0.07 | 0.12 | 0.17 |
| D | 0.95 | 1.00 | 1.05 |
| E | 0.75 | 0.80 | 0.85 |
| e | 0.35 BSC |  |  |
| HE $^{2}$ | 0.95 | 1.00 | 1.05 |
| L | 0.175 REF |  |  |
| L2 | 0.05 | 0.10 | 0.15 |
| L3 | --- | --- | 0.15 |

GENERIC MARKING DIAGRAM*


X = Specific Device Code
M = Month Code
*This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot " $\quad$ ", may or may not be present.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | SOT-953 | PAGE 1 OF 1 |

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NLX1G11AMUTCG NLX1G97MUTCG 74LS38 74LVC32ADTR2G MC74HCT20ADTR2G NLV17SZ00DFT2G NLV17SZ02DFT2G
NLV74HC02ADR2G 74HC32S14-13 74LS133 74LVC1G32Z-7 M38510/30402BDA 74LVC1G86Z-7 74LVC2G08RA3-7
NLV74HC08ADTR2G NLV74HC14ADR2G NLV74HC20ADR2G NLX2G86MUTCG 5962-8973601DA 74LVC2G02HD4-7
NLU1G00AMUTCG 74LVC2G32RA3-7 74LVC2G00HD4-7 NL17SG02P5T5G 74LVC2G00HK3-7 74LVC2G86HK3-7
NLX1G99DMUTWG NLVVHC1G00DFT2G NLVHC1G08DFT2G NLV7SZ57DFT2G NLV74VHC04DTR2G NLV27WZ86USG
NLV27WZ00USG NLU1G86CMUTCG NLU1G08CMUTCG NL17SZ32P5T5G NL17SZ00P5T5G NL17SH02P5T5G 74AUP2G00RA3-7
NLV74HC02ADTR2G NLX1G332CMUTCG NL17SG86P5T5G NL17SZ05P5T5G


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